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- *EPIC*TM (Enhanced-Performance Implanted CMOS) Submicron Process
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 > 2 V at V_{CC} = 3.3 V, T_A = 25°C
- Inputs Accept Voltages to 5.5 V
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK) and Flat (W) Packages, and DIPs (J)

description

The SN54LVC08A quadruple 2-input positive-AND gate is designed for 2.7-V to 3.6-V V_{CC} operation and the SN74LVC08A quadruple 2-input positive-AND gate is designed for 1.65-V to 3.6-V V_{CC} operation.

The 'LVC08A devices perform the Boolean function $Y = A \bullet B$ or $Y = \overline{\overline{A} + \overline{B}}$ in positive logic.

SN54LVC08A J OR W PACKAGE
SN74LVC08A D, DB, OR PW PACKAGE
(TOP VIEW)

	•				
1A [1	υ	14	h	Vee
	1.			K.	V _{CC} 4B
1B [2		13	μ	4B
1Y [3		12		4A
2A [4		11		4Y
2B [5		10		3B
2Y [6		9		ЗA
GND [7		8	μ	3Y

SN54LVC08A . . . FK PACKAGE (TOP VIEW)

	118 114 114 148 148	
1Y	3 2 1 20 19 4 18 5 17	4A
NC	5 17	NC
2A	Па 16П	4Y
NC	7 15	NC
2B	∐ 8 14 ∐	3B
	BND 3A 3A 3A	

NC - No internal connection

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

The SN54LVC08A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LVC08A is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each gate)							
INP	OUTPUT						
Α	В	Y					
Н	Н	Н					
L	Х	L					
Х	L	L					



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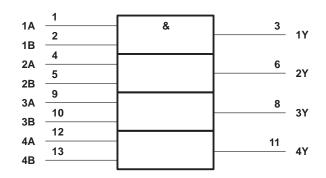
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, J, PW, and W packages.

logic diagram, each gate (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC}		–0.5 V to 6.5 V
Input voltage range, V _I (see Note 1)		–0.5 V to 6.5 V
Output voltage range, V _O (see Notes 1 and 2)		–0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)		
Output clamp current, I _{OK} (V _O < 0)		
Continuous output current, IO		±50 mA
Continuous current through V _{CC} or GND		±100 mA
Package thermal impedance, θ_{JA} (see Note 3):	: D package	127°C/W
	DB package	158°C/W
	PW package	170°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The value of V_{CC} is provided in the recommended operating conditions table.
 - 3. The package thermal impedance is calculated in accordance with JESD 51.



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			SN54	LVC08A	SN74L	VC08A	
			MIN	MAX	MIN	MAX	UNIT
	Supply voltogo	Operating	2	3.6	1.65	3.6	V
VCC	Supply voltage	Data retention only	1.5		1.5		v
		V _{CC} = 1.65 V to 1.95 V			$0.65 \times V_{CC}$		
VIH	High-level input voltage	V _{CC} = 2.3 V to 2.7 V			1.7		V
		V_{CC} = 2.7 V to 3.6 V	2		2		
VIL	Low-level input voltage	V_{CC} = 1.65 V to 1.95 V				$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V				0.7	
		$V_{CC} = 2.7 V \text{ to } 3.6 V$		0.8		0.8	
VI	Input voltage		0	5.5	0	5.5	V
VO	Output voltage		0	VCC	0	VCC	V
		V _{CC} = 1.65 V				-4	
lau	High lovel output ourrest	V _{CC} = 2.3 V				-8	
ЮН	High-level output current	$V_{CC} = 2.7 V$		-12		-12	mA
		$V_{CC} = 3 V$		-24		-24	
		V _{CC} = 1.65 V				4	
101	Low lovel output current	V _{CC} = 2.3 V				8	mA
IOL	Low-level output current	$V_{CC} = 2.7 V$		12		12	
		$V_{CC} = 3 V$		24		24	
$\Delta t / \Delta v$	Input transition rise or fall rate		0	8	0	8	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

recommended operating conditions (see Note 4)

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS		SN5	4LVC08A	1	SN74	4LVC08A		
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNIT
	I _{OH} = -100 μA	1.65 V to 3.6 V				V _{CC} -0.2			
		2.7 V to 3.6 V	V _{CC} -0.2						
	$I_{OH} = -4 \text{ mA}$	1.65 V				1.2			
VOH	I _{OH} = -8 mA	2.3 V				1.7			V
	10	2.7 V	2.2			2.2			
	$I_{OH} = -12 \text{ mA}$	3 V	2.4			2.4			
	I _{OH} = -24 mA	3 V	2.2			2.2			
	I _{OL} = 100 μA	1.65 V to 3.6 V						0.2	
		2.7 V to 3.6 V			0.2				
Ve	I _{OL} = 4 mA	1.65 V						0.45	V
VOL	I _{OL} = 8 mA	2.3 V						0.7	v
	I _{OL} = 12 mA	2.7 V			0.4			0.4	
	I _{OL} = 24 mA	3 V			0.55			0.55	
l	$V_{I} = 5.5 V \text{ or GND}$	3.6 V			±5			±5	μΑ
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	3.6 V			10			10	μA
ΔICC	One input at $V_{CC} - 0.6 V$, Other inputs at V_{CC} or GND	2.7 V to 3.6 V			500			500	μΑ
Ci	$V_{I} = V_{CC}$ or GND	3.3 V		5			5		pF

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25° C.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

				SN54L	VC08A		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} =	2.7 V	= V _{CC} ± 0.	3.3 V 3 V	UNIT
			MIN	MAX	MIN	MAX	
^t pd	A or B	Y		4.8	1	4.1	ns

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

Г							SN74L	VC08A				
	PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = ± 0.1		V _{CC} = ± 0.1		V _{CC} =	2.7 V	= ۷ _{CC} ± 0.:	3.3 V 3 V	UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
Γ	^t pd	A or B	Y	1	9.8	1	6.9		4.8	1	4.1	ns
	^t sk(o) [‡]										1	ns

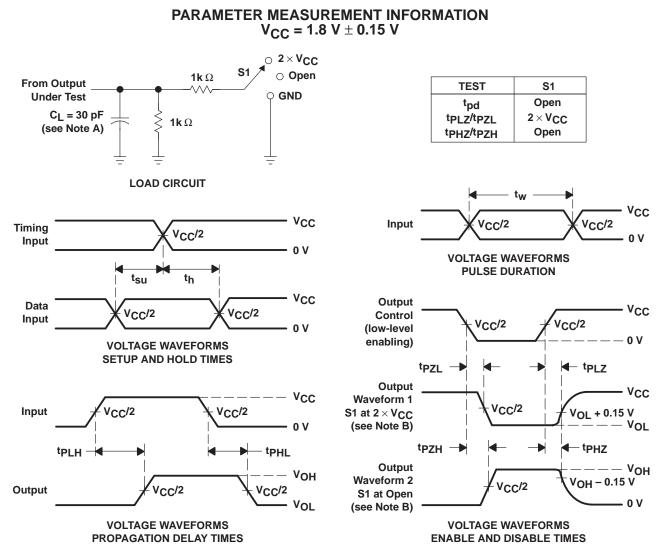
[‡] Skew between any two outputs of the same package switching in the same direction

operating characteristics, $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	V _{CC} = 1.8 V ± 0.15 V	V _{CC} = 2.5 V ± 0.2 V	V _{CC} = 3.3 V ± 0.3 V	UNIT
			TYP	TYP	TYP	
Cpd	Power dissipation capacitance per gate	f = 10 MHz	7	9.8	10	pF



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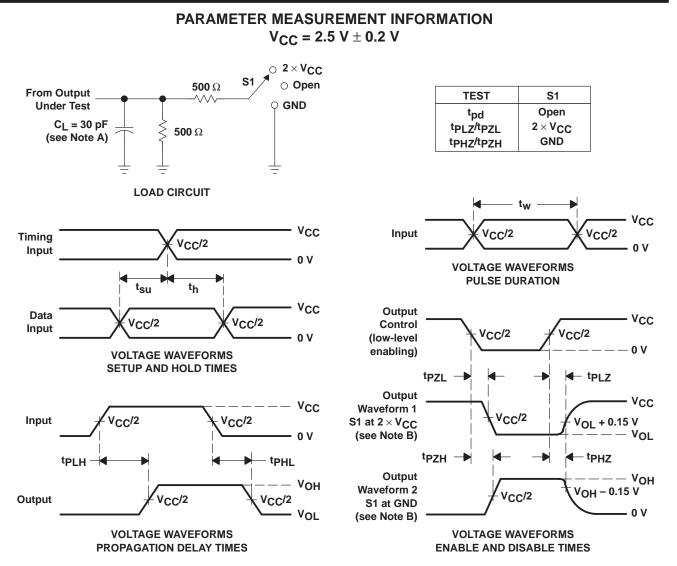


- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2 ns, t_f \leq 2 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms



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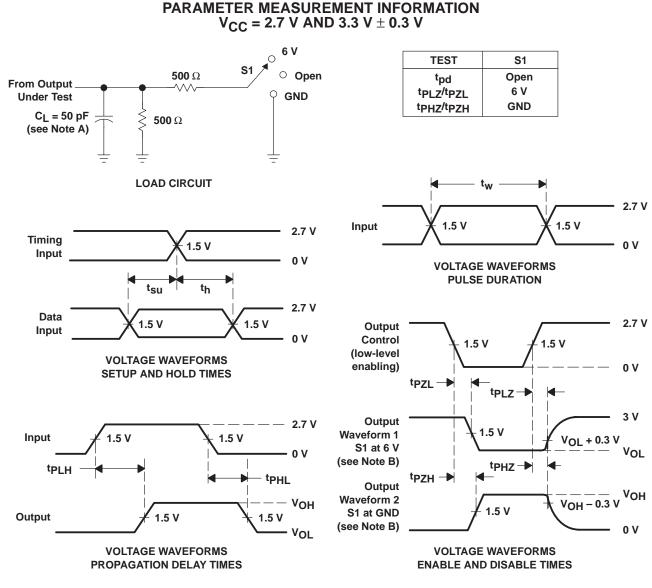


- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR≤10 MHz, Z_O = 50 Ω, t_f≤2 ns. t_f≤2 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. tp7I and tp7H are the same as t_{en} .
 - G. tpLH and tpHL are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms



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- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r \leq 2.5 ns, t_f \leq 2.5 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. tpl 7 and tpH7 are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 3. Load Circuit and Voltage Waveforms



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